

Ref : UCL/SEC/2025-26

14th January, 2026

<p>BSE Limited Corporate Relationship Department Phiroz Jeejeebhoy Towers, Dalal Street, Mumbai – 400 001</p> <p>Scrip Code : 504212</p>	<p>National Stock Exchange of India Ltd. Listing Department, Exchange Plaza, Bandra-Kurla Complex, Bandra - East Mumbai – 400 051</p> <p>Scrip Code : UNIVCABLES EQ</p>
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Dear Sirs,

**Subject: Disclosure of material event under Regulation 30 of the SEBI (LODR),
Regulations, 2015 – Manufacturing Agreement with TS Conductor
Corp, USA**

Pursuant to Regulation 30 of the SEBI (Listing Obligations and Disclosure Requirements) Regulations, 2015 (“Listing Regulations”), we wish to inform you that the Board of Directors of the Company vide Circular Resolution passed on 14th January 2026, has accorded its approval for the execution of the **Manufacturing Agreement** by and between the Company and **TS Conductor Corp, USA**.

The disclosures as required under Regulation 30 of the Listing Regulations read with SEBI Master Circular No. SEBI/HO/CFD/PoD2/CIR/P/0155 dated 11th November, 2024, are furnished in the prescribed format and enclosed herewith as **Annexure-“A”**.

This is for your information and records.

Thanking you,
Yours faithfully,
For UNIVERSAL CABLES LIMITED

(Sudeep Jain)
Company Secretary



Enclosed: Annexure – “A”



Annexure - "A"**(1) Name of the Entity with whom Manufacturing Agreement ("Agreement") is signed:**

TS Conductor Corp, a company incorporated and existing under the laws of the United States of America, having its principal place of business at 15282 Newsboy Circle Huntington Beach, California 92649, United States of America ("TS").

(2) Area of Agreement:

As per the Agreement, the Company shall manufacture and sale HTLS Conductors with TS® Aluminium Encapsulated Composite Core produced to the TS® Core specification by TS or a third party authorised by TS. TS shall supply Aluminium Encapsulated Composite Core, jointing & associated accessories and guidance for installation in its integrated form as and when required.

TS shall grant to the Company, a limited non-transferable, non-assignable and non-sublicensable license to use TS Intellectual Property during the term of the Agreement solely at the Company's facility/Plant for the purpose of manufacturing approved TS® Conductor in accordance with the terms of the Agreement.

(3) Domestic/International:

The Agreement has been entered into for manufacturing of HTLS Conductor at the Company's manufacturing facility situated at Satna, Madhya Pradesh, India.

(4) Share Exchange Ratio: Not Applicable.**(5) Scope of business operation of Agreement:**

Manufacturing and Sale of HTLS Conductor conforming to domestic and international specifications with Aluminum Encapsulated Composite Core to be supplied by TS.

(6) Details of consideration to be paid/received in Agreement:

The Company will source Aluminium Encapsulated Composite Core from TS on an arm's length basis, in accordance with mutually agreed commercial terms from time to time for manufacturing HTLS Conductor. The Company may also outsource jointing and associated accessories from TS as required for system installation.

(7) Significant terms and conditions of Agreement:

The Agreement shall initially remain valid for a period of twelve (12) months from the effective date, with a provision for renewal or reset of the term, subject to mutual written consent of the Company and TS.



(8) **Whether the acquisition would fall within related party transactions and whether the promoter/ promoter group/ group companies have any interest in the entity being acquired? If yes, nature of interest and details thereof and whether the same is done at "arm's length"**

The Agreement does not constitute a related party transaction. Neither the promoter, promoter group, nor directors have any interest in TS. The Agreement is proposed to be entered into on an arm's length basis.

(9) **Size of the Entity:**

TS is a global technology provider specialising in patented conductor solutions for the power transmission industry. TS owns patented proprietary TS conductor technology and is engaged, inter alia, in developing, manufacturing, and selling of composite-core and composite core containing conductors for electric power transmission and distribution sectors, including pultrusion of composites, encapsulation of composite core with conforming techniques, and strand manufacturing with conforming and stranding processes.

(10) **Rationale and benefit expected:**

The Agreement will enable the Company to manufacture advanced HTLS Conductors with Aluminium Encapsulated Composite Core and strengthen its Conductor portfolio in order to seize emerging opportunities in high performance Conductor market in the fast growing power transmission solutions market.

